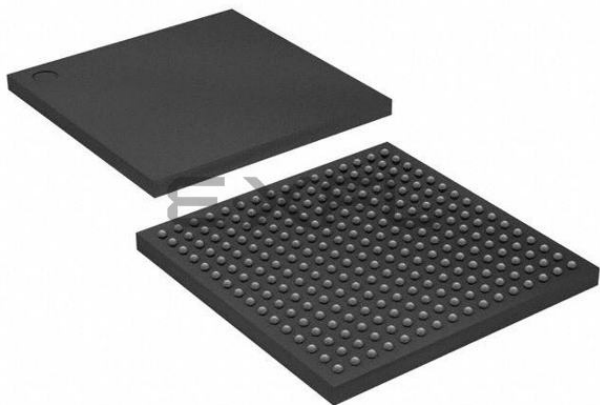




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Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

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The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Active
Number of LABs/CLBs	2816
Number of Logic Elements/Cells	25344
Total RAM Bits	589824
Number of I/O	161
Number of Gates	1400000
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	256-LBGA
Supplier Device Package	256-FTBGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc3s1400a-5ftg256c

Spartan-3A FPGA Design Documentation

The functionality of the Spartan®-3A FPGA Family is described in the following documents. The topics covered in each guide is listed below.

- **DS706: Extended Spartan-3A Family Overview**
www.xilinx.com/support/documentation/data_sheets/ds706.pdf
- **UG331: Spartan-3 Generation FPGA User Guide**
www.xilinx.com/support/documentation/user_guides/ug331.pdf
 - Clocking Resources
 - Digital Clock Managers (DCMs)
 - Block RAM
 - Configurable Logic Blocks (CLBs)
 - Distributed RAM
 - SRL16 Shift Registers
 - Carry and Arithmetic Logic
 - I/O Resources
 - Embedded Multiplier Blocks
 - Programmable Interconnect
 - ISE® Software Design Tools
 - IP Cores
 - Embedded Processing and Control Solutions
 - Pin Types and Package Overview
 - Package Drawings
 - Powering FPGAs
 - Power Management
- **UG332: Spartan-3 Generation Configuration User Guide**
www.xilinx.com/support/documentation/user_guides/ug332.pdf
 - Configuration Overview
 - Configuration Pins and Behavior
 - Bitstream Sizes

- Detailed Descriptions by Mode
 - Master Serial Mode using Xilinx® Platform Flash PROM
 - Master SPI Mode using Commodity SPI Serial Flash PROM
 - Master BPI Mode using Commodity Parallel NOR Flash PROM
 - Slave Parallel (SelectMAP) using a Processor
 - Slave Serial using a Processor
 - JTAG Mode
- ISE iMPACT Programming Examples
- MultiBoot Reconfiguration
- Design Authentication using Device DNA

For application examples, see the Spartan-3A FPGA application notes.

- **Spartan-3A FPGA Application Notes**
www.xilinx.com/support/documentation/spartan-3a_application_notes.htm

For specific hardware examples, please see the Spartan-3A FPGA Starter Kit board web page, which has links to various design examples and the user guide.

- **Spartan-3A/3AN FPGA Starter Kit Board Page**
www.xilinx.com/s3astarter
- **UG334: Spartan-3A/3AN FPGA Starter Kit User Guide**
www.xilinx.com/support/documentation/boards_and_kits/ug334.pdf

For information on the XA Automotive version of the Spartan-3A family, see the following data sheet.

- XA Spartan-3A Automotive FPGA Family Data Sheet
www.xilinx.com/support/documentation/data_sheets/ds681.pdf

Create a Xilinx user account and sign up to receive automatic e-mail notification whenever this data sheet or the associated user guides are updated.

- Sign Up for Alerts
www.xilinx.com/support/answers/18683.htm

Table 22: Propagation Times for the IOB Input Path(Continued)

Symbol	Description	Conditions	DELAY_VALUE	Device	Speed Grade		Units
					-5	-4	
					Max	Max	
T _{IOPID}	The time it takes for data to travel from the Input pin to the I output with the input delay programmed	LVCMOS25 ⁽²⁾	15	XC3S200A	5.43	6.24	ns
			16		5.75	6.59	ns
			1	XC3S400A	1.32	1.43	ns
			2		1.67	1.83	ns
			3		1.90	2.07	ns
			4		2.33	2.52	ns
			5		2.60	2.91	ns
			6		2.94	3.20	ns
			7		3.23	3.51	ns
			8		3.50	3.85	ns
			9		3.18	3.55	ns
			10		3.53	3.95	ns
			11		3.76	4.20	ns
			12		4.26	4.67	ns
			13		4.51	4.97	ns
			14		4.85	5.32	ns
			15		5.14	5.64	ns
			16		5.40	5.95	ns
			1	XC3S700A	1.84	1.87	ns
			2		2.20	2.27	ns
			3		2.46	2.60	ns
			4		2.93	3.15	ns
			5		3.21	3.45	ns
			6		3.54	3.80	ns
			7		3.86	4.16	ns
			8		4.13	4.48	ns
			9		3.82	4.19	ns
			10		4.17	4.58	ns
			11		4.43	4.89	ns
			12		4.95	5.49	ns
			13		5.22	5.83	ns
			14		5.57	6.21	ns
			15		5.89	6.55	ns
			16		6.16	6.89	ns
			1	XC3S1400A	1.95	2.18	ns
			2		2.29	2.59	ns
			3		2.54	2.84	ns
			4		2.96	3.30	ns

Output Timing Adjustments

Table 26: Output Timing Adjustments for IOB

Convert Output Time from LVCMOS25 with 12mA Drive and Fast Slew Rate to the Following Signal Standard (IOSTANDARD)			Add the Adjustment Below		Units
			Speed Grade		
			-5	-4	
Single-Ended Standards					
LVTTL	Slow	2 mA	5.58	5.58	ns
		4 mA	3.16	3.16	ns
		6 mA	3.17	3.17	ns
		8 mA	2.09	2.09	ns
		12 mA	1.62	1.62	ns
		16 mA	1.24	1.24	ns
		24 mA	2.74 ⁽³⁾	2.74 ⁽³⁾	ns
	Fast	2 mA	3.03	3.03	ns
		4 mA	1.71	1.71	ns
		6 mA	1.71	1.71	ns
		8 mA	0.53	0.53	ns
		12 mA	0.53	0.53	ns
		16 mA	0.59	0.59	ns
		24 mA	0.60	0.60	ns
	QuietIO	2 mA	27.67	27.67	ns
		4 mA	27.67	27.67	ns
		6 mA	27.67	27.67	ns
		8 mA	16.71	16.71	ns
		12 mA	16.67	16.67	ns
		16 mA	16.22	16.22	ns
		24 mA	12.11	12.11	ns

Table 26: Output Timing Adjustments for IOB(Continued)

Convert Output Time from LVCMOS25 with 12mA Drive and Fast Slew Rate to the Following Signal Standard (IOSTANDARD)			Add the Adjustment Below		Units
			Speed Grade		
			-5	-4	
LVCMOS33	Slow	2 mA	5.58	5.58	ns
		4 mA	3.17	3.17	ns
		6 mA	3.17	3.17	ns
		8 mA	2.09	2.09	ns
		12 mA	1.24	1.24	ns
		16 mA	1.15	1.15	ns
		24 mA	2.55 ⁽³⁾	2.55 ⁽³⁾	ns
	Fast	2 mA	3.02	3.02	ns
		4 mA	1.71	1.71	ns
		6 mA	1.72	1.72	ns
		8 mA	0.53	0.53	ns
		12 mA	0.59	0.59	ns
		16 mA	0.59	0.59	ns
		24 mA	0.51	0.51	ns
	QuietIO	2 mA	27.67	27.67	ns
		4 mA	27.67	27.67	ns
		6 mA	27.67	27.67	ns
		8 mA	16.71	16.71	ns
		12 mA	16.29	16.29	ns
		16 mA	16.18	16.18	ns
		24 mA	12.11	12.11	ns

Block RAM Timing

Table 35: Block RAM Timing

Symbol	Description	Speed Grade				Units
		-5		-4		
		Min	Max	Min	Max	
Clock-to-Output Times						
T _{RCKO}	When reading from block RAM, the delay from the active transition at the CLK input to data appearing at the DOUT output	–	2.06	–	2.49	ns
Setup Times						
T _{RCKK_ADDR}	Setup time for the ADDR inputs before the active transition at the CLK input of the block RAM	0.32	–	0.36	–	ns
T _{RDCK_DIB}	Setup time for data at the DIN inputs before the active transition at the CLK input of the block RAM	0.28	–	0.31	–	ns
T _{RCKK_ENB}	Setup time for the EN input before the active transition at the CLK input of the block RAM	0.69	–	0.77	–	ns
T _{RCKK_WEB}	Setup time for the WE input before the active transition at the CLK input of the block RAM	1.12	–	1.26	–	ns
Hold Times						
T _{RCKC_ADDR}	Hold time on the ADDR inputs after the active transition at the CLK input	0	–	0	–	ns
T _{RCKD_DIB}	Hold time on the DIN inputs after the active transition at the CLK input	0	–	0	–	ns
T _{RCKC_ENB}	Hold time on the EN input after the active transition at the CLK input	0	–	0	–	ns
T _{RCKC_WEB}	Hold time on the WE input after the active transition at the CLK input	0	–	0	–	ns
Clock Timing						
T _{BPWH}	High pulse width of the CLK signal	1.56	–	1.79	–	ns
T _{BPWL}	Low pulse width of the CLK signal	1.56	–	1.79	–	ns
Clock Frequency						
F _{BRAM}	Block RAM clock frequency	0	320	0	280	MHz

Notes:

1. The numbers in this table are based on the operating conditions set forth in [Table 8](#).

Miscellaneous DCM Timing

Table 42: Miscellaneous DCM Timing

Symbol	Description	Min	Max	Units
DCM_RST_PW_MIN	Minimum duration of a RST pulse width	3	—	CLKIN cycles
DCM_RST_PW_MAX ⁽²⁾	Maximum duration of a RST pulse width	N/A	N/A	seconds
		N/A	N/A	seconds
DCM_CONFIG_LAG_TIME ⁽³⁾	Maximum duration from V_{CCINT} applied to FPGA configuration successfully completed (DONE pin goes High) and clocks applied to DCM DLL	N/A	N/A	minutes
		N/A	N/A	minutes

Notes:

1. This limit only applies to applications that use the DCM DLL outputs (CLK0, CLK90, CLK180, CLK270, CLK2X, CLK2X180, and CLKDV). The DCM DFS outputs (CLKFX, CLKFX180) are unaffected.
2. This specification is equivalent to the Virtex®-4 DCM_RESET specification. This specification does not apply for Spartan-3A FPGAs.
3. This specification is equivalent to the Virtex-4 TCONFIG specification. This specification does not apply for Spartan-3A FPGAs.

DNA Port Timing

Table 43: DNA_PORT Interface Timing

Symbol	Description	Min	Max	Units
T_{DNASSU}	Setup time on SHIFT before the rising edge of CLK	1.0	—	ns
T_{DNASH}	Hold time on SHIFT after the rising edge of CLK	0.5	—	ns
T_{DNADSU}	Setup time on DIN before the rising edge of CLK	1.0	—	ns
T_{DNADH}	Hold time on DIN after the rising edge of CLK	0.5	—	ns
T_{DNARSU}	Setup time on READ before the rising edge of CLK	5.0	10,000	ns
T_{DNARH}	Hold time on READ after the rising edge of CLK	0	—	ns
$T_{DNADCKO}$	Clock-to-output delay on DOUT after rising edge of CLK	0.5	1.5	ns
$T_{DNACLKF}$	CLK frequency	0	100	MHz
$T_{DNACLKH}$	CLK High time	1.0	∞	ns
$T_{DNACLKL}$	CLK Low time	1.0	∞	ns

Notes:

1. The minimum READ pulse width is 5 ns, the maximum READ pulse width is 10 μ s.
2. The numbers in this table are based on the operating conditions set forth in Table 8.

Configuration Clock (CCLK) Characteristics

Table 46: Master Mode CCLK Output Period by *ConfigRate* Option Setting

Symbol	Description	ConfigRate Setting	Temperature Range	Minimum	Maximum	Units
T_{CCLK1}	CCLK clock period by ConfigRate setting	1 (power-on value)	Commercial	1,254	2,500	ns
			Industrial	1,180		ns
T_{CCLK3}		3	Commercial	413	833	ns
			Industrial	390		ns
T_{CCLK6}		6 (default)	Commercial	207	417	ns
			Industrial	195		ns
T_{CCLK7}		7	Commercial	178	357	ns
			Industrial	168		ns
T_{CCLK8}		8	Commercial	156	313	ns
			Industrial	147		ns
T_{CCLK10}		10	Commercial	123	250	ns
			Industrial	116		ns
T_{CCLK12}		12	Commercial	103	208	ns
			Industrial	97		ns
T_{CCLK13}		13	Commercial	93	192	ns
			Industrial	88		ns
T_{CCLK17}		17	Commercial	72	147	ns
			Industrial	68		ns
T_{CCLK22}		22	Commercial	54	114	ns
			Industrial	51		ns
T_{CCLK25}		25	Commercial	47	100	ns
			Industrial	45		ns
T_{CCLK27}		27	Commercial	44	93	ns
			Industrial	42		ns
T_{CCLK33}		33	Commercial	36	76	ns
			Industrial	34		ns
T_{CCLK44}		44	Commercial	26	57	ns
			Industrial	25		ns
T_{CCLK50}		50	Commercial	22	50	ns
			Industrial	21		ns
T_{CCLK100}		100	Commercial	11.2	25	ns
			Industrial	10.6		ns

Notes:

1. Set the **ConfigRate** option value when generating a configuration bitstream.

Table 47: Master Mode CCLK Output Frequency by ConfigRate Option Setting

Symbol	Description	ConfigRate Setting	Temperature Range	Minimum	Maximum	Units
F _{CCLK1}	Equivalent CCLK clock frequency by ConfigRate setting	1 (power-on value)	Commercial	0.400	0.797	MHz
			Industrial		0.847	MHz
F _{CCLK3}		3	Commercial	1.20	2.42	MHz
			Industrial		2.57	MHz
F _{CCLK6}		6 (default)	Commercial	2.40	4.83	MHz
			Industrial		5.13	MHz
F _{CCLK7}		7	Commercial	2.80	5.61	MHz
			Industrial		5.96	MHz
F _{CCLK8}		8	Commercial	3.20	6.41	MHz
			Industrial		6.81	MHz
F _{CCLK10}		10	Commercial	4.00	8.12	MHz
			Industrial		8.63	MHz
F _{CCLK12}		12	Commercial	4.80	9.70	MHz
			Industrial		10.31	MHz
F _{CCLK13}		13	Commercial	5.20	10.69	MHz
			Industrial		11.37	MHz
F _{CCLK17}		17	Commercial	6.80	13.74	MHz
			Industrial		14.61	MHz
F _{CCLK22}		22	Commercial	8.80	18.44	MHz
			Industrial		19.61	MHz
F _{CCLK25}		25	Commercial	10.00	20.90	MHz
			Industrial		22.23	MHz
F _{CCLK27}		27	Commercial	10.80	22.39	MHz
			Industrial		23.81	MHz
F _{CCLK33}		33	Commercial	13.20	27.48	MHz
			Industrial		29.23	MHz
F _{CCLK44}		44	Commercial	17.60	37.60	MHz
			Industrial		40.00	MHz
F _{CCLK50}		50	Commercial	20.00	44.80	MHz
			Industrial		47.66	MHz
F _{CCLK100}		100	Commercial	40.00	88.68	MHz
			Industrial		94.34	MHz

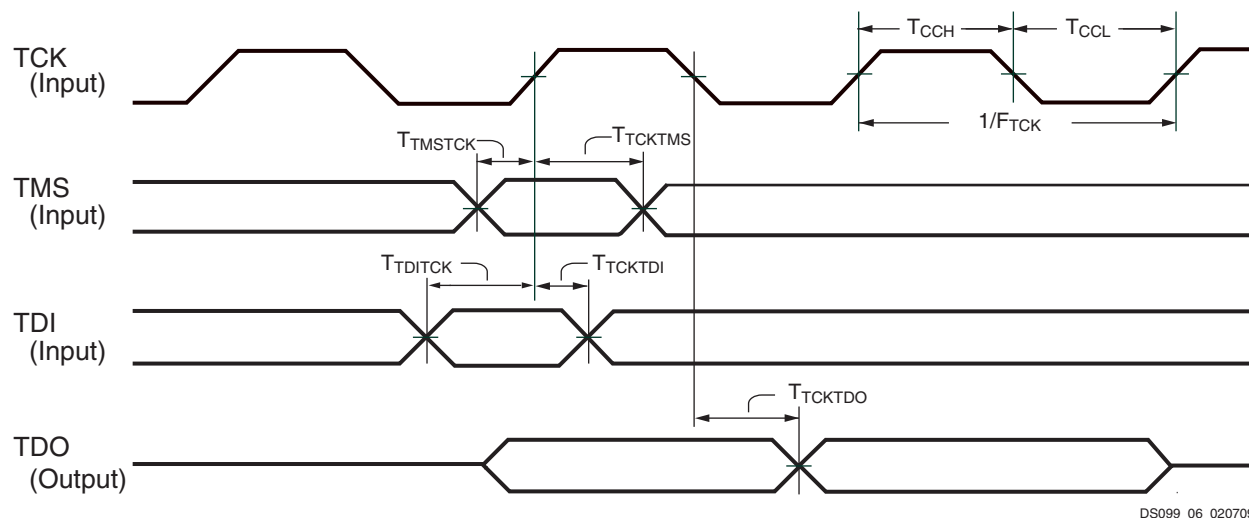
Table 48: Master Mode CCLK Output Minimum Low and High Time

Symbol	Description		ConfigRate Setting																Units
			1	3	6	7	8	10	12	13	17	22	25	27	33	44	50	100	
T _{MCCL} , T _{MCCH}	Master Mode CCLK Minimum Low and High Time	Commercial	595	196	98.3	84.5	74.1	58.4	48.9	44.1	34.2	25.6	22.3	20.9	17.1	12.3	10.4	5.3	ns
		Industrial	560	185	92.6	79.8	69.8	55.0	46.0	41.8	32.3	24.2	21.4	20.0	16.2	11.9	10.0	5.0	ns

Table 49: Slave Mode CCLK Input Low and High Time

Symbol	Description	Min	Max	Units
T _{SCCL} , T _{SCCH}	CCLK Low and High time	5	∞	ns

IEEE 1149.1/1532 JTAG Test Access Port Timing



DS099_06_020709

Figure 16: JTAG Waveforms

Table 56: Timing for the JTAG Test Access Port

Symbol	Description		All Speed Grades		Units
			Min	Max	
Clock-to-Output Times					
T _{TCKTDO}	The time from the falling transition on the TCK pin to data appearing at the TDO pin		1.0	11.0	ns
Setup Times					
T _{TDITCK}	The time from the setup of data at the TDI pin to the rising transition at the TCK pin	All devices and functions except those shown below	7.0	—	ns
		Boundary scan commands (INTEST, EXTEST, SAMPLE) on XC3S700A and XC3S1400A FPGAs	11.0		
T _{TMSTCK}	The time from the setup of a logic level at the TMS pin to the rising transition at the TCK pin		7.0	—	ns
Hold Times					
T _{TCKTDI}	The time from the rising transition at the TCK pin to the point when data is last held at the TDI pin	All functions except those shown below	0	—	ns
		Configuration commands (CFG_IN, ISC_PROGRAM)	2.0		
T _{TCKTMS}	The time from the rising transition at the TCK pin to the point when a logic level is last held at the TMS pin		0	—	ns
Clock Timing					
T _{CCH}	The High pulse width at the TCK pin	All functions except ISC_DNA command	5	—	ns
T _{CCL}	The Low pulse width at the TCK pin		5	—	ns
T _{CCHDNA}	The High pulse width at the TCK pin	During ISC_DNA command	10	10,000	ns
T _{CCLDNA}	The Low pulse width at the TCK pin		10	10,000	ns
F _{TCK}	Frequency of the TCK signal	All operations on XC3S50A, XC3S200A, and XC3S400A FPGAs and for BYPASS or HIGHZ instructions on all FPGAs	0	33	MHz
		All operations on XC3S700A and XC3S1400A FPGAs, except for BYPASS or HIGHZ instructions		20	

Notes:

- The numbers in this table are based on the operating conditions set forth in [Table 8](#).
- For details on JTAG see Chapter 9 “JTAG Configuration Mode and Boundary-Scan” in [UG332 Spartan-3 Generation Configuration User Guide](#).

Introduction

This section describes how the various pins on a Spartan®-3A FPGA connect within the supported component packages, and provides device-specific thermal characteristics. For general information on the pin functions and the package characteristics, see the Packaging section of UG331: *Spartan-3 Generation FPGA User Guide*.

- **UG331: Spartan-3 Generation FPGA User Guide**
www.xilinx.com/support/documentation/user_guides/ug331.pdf

Spartan-3A FPGAs are available in both standard and Pb-free, RoHS versions of each package, with the Pb-free version adding a “G” to the middle of the package code.

Except for the thermal characteristics, all information for the standard package applies equally to the Pb-free package.

Pin Types

Most pins on a Spartan-3A FPGA are general-purpose, user-defined I/O pins. There are, however, up to 12 different functional types of pins on Spartan-3A FPGA packages, as outlined in Table 57. In the package footprint drawings that follow, the individual pins are color-coded according to pin type as in the table.

Table 57: Types of Pins on Spartan-3A FPGAs

Type / Color Code	Description	Pin Name(s) in Type
I/O	Unrestricted, general-purpose user-I/O pin. Most pins can be paired together to form differential I/Os.	IO_# IO_Lxxy_#
INPUT	Unrestricted, general-purpose input-only pin. This pin does not have an output structure, differential termination resistor, or PCI clamp diode.	IP_# IP_Lxxy_#
DUAL	Dual-purpose pin used in some configuration modes during the configuration process and then usually available as a user I/O after configuration. If the pin is not used during configuration, this pin behaves as an I/O-type pin. See UG332: <i>Spartan-3 Generation Configuration User Guide</i> for additional information on these signals.	M[2:0] PUDC_B CCLK MOSI/CSI_B D[7:1] D0/DIN DOUT CSO_B RDWR_B INIT_B A[25:0] VS[2:0] LDC[2:0] HDC
VREF	Dual-purpose pin that is either a user-I/O pin or Input-only pin, or, along with all other VREF pins in the same bank, provides a reference voltage input for certain I/O standards. If used for a reference voltage within a bank, all VREF pins within the bank must be connected.	IP/VREF_# IP_Lxxy_#/VREF_# IO/VREF_# IO_Lxxy_#/VREF_#
CLK	Either a user-I/O pin or an input to a specific clock buffer driver. Most packages have 16 global clock inputs that optionally clock the entire device. The exceptions are the TQ144 and the XC3S50A in the FT256 package). The RHCLK inputs optionally clock the right half of the device. The LHCLK inputs optionally clock the left half of the device. See the Using Global Clock Resources chapter in UG331: <i>Spartan-3 Generation FPGA User Guide</i> for additional information on these signals.	IO_Lxxy_#/GCLK[15:0], IO_Lxxy_#/LHCLK[7:0], IO_Lxxy_#/RHCLK[7:0]
CONFIG	Dedicated configuration pin, two per device. Not available as a user-I/O pin. Every package has two dedicated configuration pins. These pins are powered by VCCAUX. See the UG332: <i>Spartan-3 Generation Configuration User Guide</i> for additional information on the DONE and PROG_B signals.	DONE, PROG_B

Table 59: Maximum User I/O by Package

Device	Package	Maximum User I/Os and Input-Only	Maximum Input-Only	Maximum Differential Pairs	All Possible I/Os by Type					
					I/O	INPUT	DUAL	VREF	CLK	N.C.
XC3S50A	VQ100	68	6	60	17	2	20	6	23	0
XC3S200A		68	6	60	17	2	20	6	23	0
XC3S50A	TQ144	108	7	50	42	2	26	8	30	0
XC3S50A	FT256	144	32	64	53	20	26	15	30	51
XC3S200A		195	35	90	69	21	52	21	32	0
XC3S400A		195	35	90	69	21	52	21	32	0
XC3S700A		161	13	60	59	2	52	18	30	0
XC3S1400A		161	13	60	59	2	52	18	30	0
XC3S200A	FG320	248	56	112	101	40	52	23	32	3
XC3S400A		251	59	112	101	42	52	24	32	0
XC3S400A	FG400	311	63	142	155	46	52	26	32	0
XC3S700A		311	63	142	155	46	52	26	32	0
XC3S700A	FG484	372	84	165	194	61	52	33	32	3
XC3S1400A		375	87	165	195	62	52	34	32	0
XC3S1400A	FG676	502	94	227	313	67	52	38	32	17

Notes:

1. Some VREFs are on INPUT pins. See pinout tables for details.

Electronic versions of the package pinout tables and footprints are available for download from the Xilinx website. Using a spreadsheet program, the data can be sorted and reformatted according to any specific needs. Similarly, the ASCII-text file is easily parsed by most scripting programs.

http://www.xilinx.com/support/documentation/data_sheets/s3a_pin.zip

Table 63: Spartan-3A VQ100 Pinout(Continued)

2	IO_L12P_2/D1 (3S50A) IO_L11N_2/D1 (3S200A)	P52	DUAL
2	IP_2/VREF_2	P39	VREF
2	VCCO_2	P26	VCCO
2	VCCO_2	P45	VCCO
3	IO_L01N_3	P4	IO
3	IO_L01P_3	P3	IO
3	IO_L02N_3	P6	IO
3	IO_L02P_3	P5	IO
3	IO_L03N_3/LHCLK1	P10	CLK
3	IO_L03P_3/LHCLK0	P9	CLK
3	IO_L04N_3/IRDY2/LHCLK3	P13	CLK
3	IO_L04P_3/LHCLK2	P12	CLK
3	IO_L05N_3/LHCLK7	P16	CLK
3	IO_L05P_3/TRDY2/LHCLK6	P15	CLK
3	IO_L06N_3	P20	IO
3	IO_L06P_3	P19	IO
3	IP_3	P21	IP
3	IP_3/VREF_3	P7	VREF
3	VCCO_3	P11	VCCO
GND	GND	P14	GND
GND	GND	P18	GND
GND	GND	P42	GND
GND	GND	P47	GND
GND	GND	P58	GND
GND	GND	P63	GND
GND	GND	P69	GND
GND	GND	P74	GND
GND	GND	P8	GND
GND	GND	P80	GND
GND	GND	P87	GND
GND	GND	P91	GND
GND	GND	P95	GND
VCCAUX	DONE	P54	CONFIG
VCCAUX	PROG_B	P100	CONFIG
VCCAUX	TCK	P76	JTAG
VCCAUX	TDI	P2	JTAG
VCCAUX	TDO	P75	JTAG
VCCAUX	TMS	P1	JTAG
VCCAUX	VCCAUX	P22	VCCAUX
VCCAUX	VCCAUX	P55	VCCAUX
VCCAUX	VCCAUX	P92	VCCAUX

Table 63: Spartan-3A VQ100 Pinout(Continued)

VCCINT	VCCINT	P17	VCCINT
VCCINT	VCCINT	P38	VCCINT
VCCINT	VCCINT	P66	VCCINT
VCCINT	VCCINT	P81	VCCINT

VQ100 Footprint (XC3S50A)

Note pin 1 indicator in top-left corner and logo orientation.

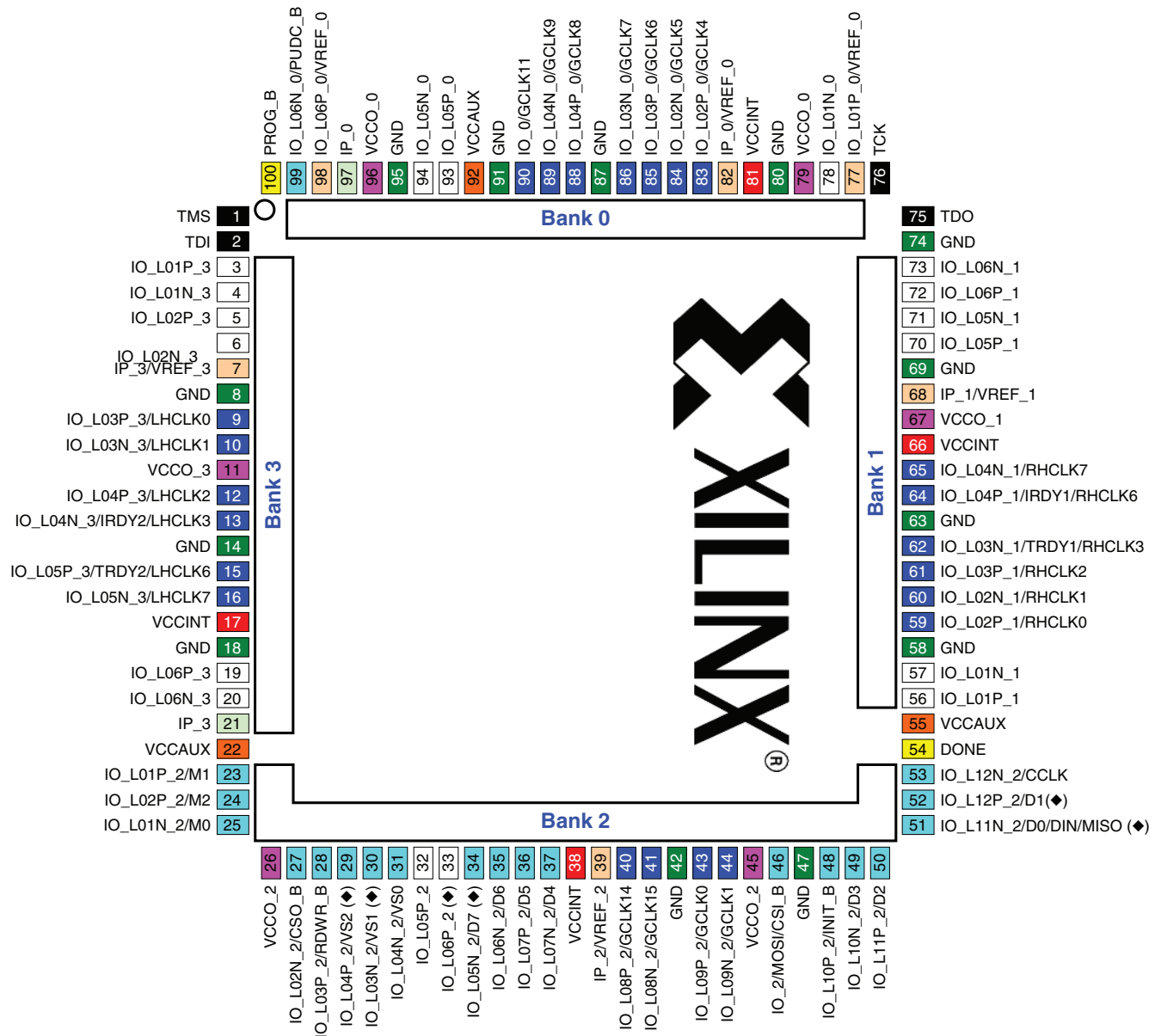


Figure 17: VQ100 Package Footprint - XC3S50A (Top View)

17	IO: Unrestricted, general-purpose user I/O	20	DUAL: Configuration pins, then possible user I/O	6	VREF: User I/O or input voltage reference for bank
2	INPUT: Unrestricted, general-purpose input pin	23	CLK: User I/O, input, or global buffer input	6	VCCO: Output voltage supply for bank
2	CONFIG: Dedicated configuration pins	4	JTAG: Dedicated JTAG port pins	4	VCCINT: Internal core supply voltage (+1.2V)
0	N.C.: Not connected	13	GND: Ground	3	VCCAUX: Auxiliary supply voltage

TQ144 Footprint

Note pin 1 indicator in top-left corner and logo orientation.

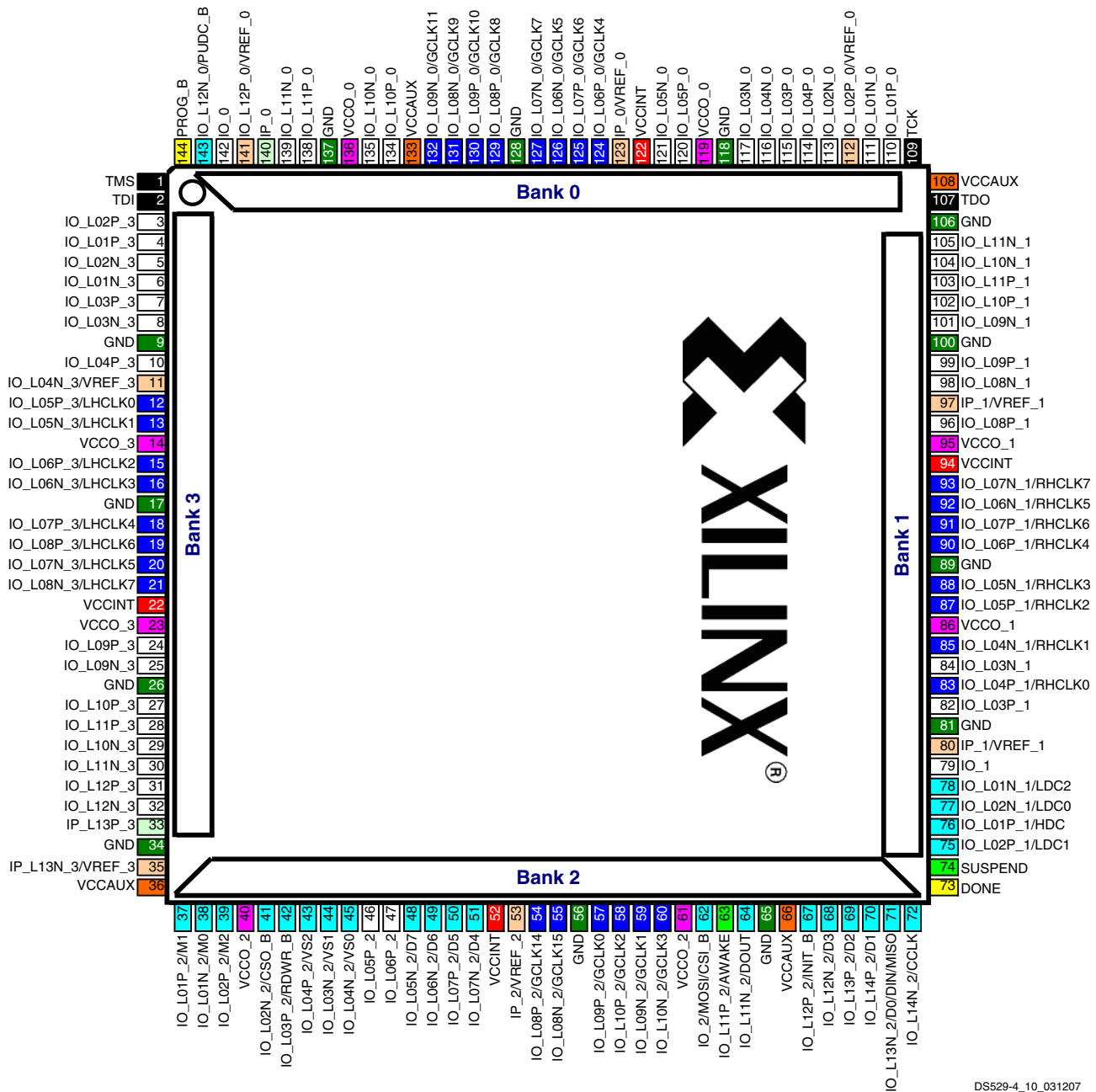


Figure 19: TQ144 Package Footprint (Top View)

42	I/O: Unrestricted, general-purpose user I/O	25	DUAL: Configuration pins, then possible user I/O	8	VREF: User I/O or input voltage reference for bank
2	INPUT: Unrestricted, general-purpose input pin	30	CLK: User I/O, input, or global buffer input	8	VCCO: Output voltage supply for bank
2	CONFIG: Dedicated configuration pins	4	JTAG: Dedicated JTAG port pins	4	VCCINT: Internal core supply voltage (+1.2V)
0	N.C.: Not connected	13	GND: Ground	4	VCCAUX: Auxiliary supply voltage
2	SUSPEND: Dedicated SUSPEND and dual-purpose AWAKE Power Management pins				

Table 68: Spartan-3A FT256 Pinout (XC3S50A, XC3S200A, XC3S400) (Continued)

Bank	XC3S50A	XC3S200A XC3S400A	FT256 Ball	Type
0	IO_L17P_0	IO_L17P_0	A5	I/O
0	IO_L18N_0	IO_L18N_0	B4	I/O
0	IO_L18P_0	IO_L18P_0	A4	I/O
0	IO_L19N_0	IO_L19N_0	B3	I/O
0	IO_L19P_0	IO_L19P_0	A3	I/O
0	IO_L20N_0/ PUDC_B	IO_L20N_0/ PUDC_B	D5	DUAL
0	IO_L20P_0/ VREF_0	IO_L20P_0/ VREF_0	C4	VREF
0	IP_0	IP_0	D6	INPUT
0	IP_0	IP_0	D12	INPUT
0	IP_0	IP_0	E6	INPUT
0	IP_0	IP_0	F7	INPUT
0	IP_0	IP_0	F9	INPUT
0	IP_0	IP_0	F10	INPUT
0	IP_0/VREF_0	IP_0/VREF_0	E9	VREF
0	VCCO_0	VCCO_0	B5	VCCO
0	VCCO_0	VCCO_0	B9	VCCO
0	VCCO_0	VCCO_0	B13	VCCO
0	VCCO_0	VCCO_0	E8	VCCO
1	IO_L01N_1/ LDC2	IO_L01N_1/ LDC2	N14	DUAL
1	IO_L01P_1/ HDC	IO_L01P_1/ HDC	N13	DUAL
1	IO_L02N_1/ LDC0	IO_L02N_1/ LDC0	P15	DUAL
1	IO_L02P_1/ LDC1	IO_L02P_1/ LDC1	R15	DUAL
1	IO_L03N_1	IO_L03N_1/A1	N16	DUAL
1	IO_L03P_1	IO_L03P_1/A0	P16	DUAL
1	N.C. (◆)	IO_L05N_1/ VREF_1	M14	VREF
1	N.C. (◆)	IO_L05P_1	M13	I/O
1	N.C. (◆)	IO_L06N_1/A3	K13	DUAL
1	N.C. (◆)	IO_L06P_1/A2	L13	DUAL
1	N.C. (◆)	IO_L07N_1/A5	M16	DUAL
1	N.C. (◆)	IO_L07P_1/A4	M15	DUAL
1	N.C. (◆)	IO_L08N_1/A7	L16	DUAL
1	N.C. (◆)	IO_L08P_1/A6	L14	DUAL
1	IO_L10N_1	IO_L10N_1/A9	J13	DUAL
1	IO_L10P_1	IO_L10P_1/A8	J12	DUAL
1	IO_L11N_1/ RHCLK1	IO_L11N_1/ RHCLK1	K14	RHCLK
1	IO_L11P_1/ RHCLK0	IO_L11P_1/ RHCLK0	K15	RHCLK

Table 68: Spartan-3A FT256 Pinout (XC3S50A, XC3S200A, XC3S400) (Continued)

Bank	XC3S50A	XC3S200A XC3S400A	FT256 Ball	Type
1	IO_L12N_1/ TRDY1/RHCLK3	IO_L12N_1/ TRDY1/RHCLK3	J16	RHCLK
1	IO_L12P_1/ RHCLK2	IO_L12P_1/ RHCLK2	K16	RHCLK
1	IO_L14N_1/ RHCLK5	IO_L14N_1/ RHCLK5	H14	RHCLK
1	IO_L14P_1/ RHCLK4	IO_L14P_1/ RHCLK4	J14	RHCLK
1	IO_L15N_1/ RHCLK7	IO_L15N_1/ RHCLK7	H16	RHCLK
1	IO_L15P_1/ IRDY1/RHCLK6	IO_L15P_1/ IRDY1/RHCLK6	H15	RHCLK
1	N.C. (◆)	IO_L16N_1/A11	F16	DUAL
1	N.C. (◆)	IO_L16P_1/A10	G16	DUAL
1	N.C. (◆)	IO_L17N_1/A13	G14	DUAL
1	N.C. (◆)	IO_L17P_1/A12	H13	DUAL
1	N.C. (◆)	IO_L18N_1/A15	F15	DUAL
1	N.C. (◆)	IO_L18P_1/A14	E16	DUAL
1	N.C. (◆)	IO_L19N_1/A17	F14	DUAL
1	N.C. (◆)	IO_L19P_1/A16	G13	DUAL
1	IO_L20N_1	IO_L20N_1/A19	F13	DUAL
1	IO_L20P_1	IO_L20P_1/A18	E14	DUAL
1	IO_L22N_1	IO_L22N_1/A21	D15	DUAL
1	IO_L22P_1	IO_L22P_1/A20	D16	DUAL
1	IO_L23N_1	IO_L23N_1/A23	D14	DUAL
1	IO_L23P_1	IO_L23P_1/A22	E13	DUAL
1	IO_L24N_1	IO_L24N_1/A25	C15	DUAL
1	IO_L24P_1	IO_L24P_1/A24	C16	DUAL
1	IP_L04N_1/ VREF_1	IP_L04N_1/ VREF_1	K12	VREF
1	IP_L04P_1	IP_L04P_1	K11	INPUT
1	N.C. (◆)	IP_L09N_1	J11	INPUT
1	N.C. (◆)	IP_L09P_1/ VREF_1	J10	VREF
1	IP_L13N_1	IP_L13N_1	H11	INPUT
1	IP_L13P_1	IP_L13P_1	H10	INPUT
1	IP_L21N_1	IP_L21N_1	G11	INPUT
1	IP_L21P_1/ VREF_1	IP_L21P_1/ VREF_1	G12	VREF
1	IP_L25N_1	IP_L25N_1	F11	INPUT
1	IP_L25P_1/ VREF_1	IP_L25P_1/ VREF_1	F12	VREF
1	VCCO_1	VCCO_1	E15	VCCO
1	VCCO_1	VCCO_1	H12	VCCO
1	VCCO_1	VCCO_1	J15	VCCO
1	VCCO_1	VCCO_1	N15	VCCO

Table 68: Spartan-3A FT256 Pinout (XC3S50A, XC3S200A, XC3S400) (Continued)

Bank	XC3S50A	XC3S200A XC3S400A	FT256 Ball	Type
2	IO_L01N_2/M0	IO_L01N_2/M0	P4	DUAL
2	IO_L01P_2/M1	IO_L01P_2/M1	N4	DUAL
2	IO_L02N_2/ CSO_B	IO_L02N_2/ CSO_B	T2	DUAL
2	IO_L02P_2/M2	IO_L02P_2/M2	R2	DUAL
2	IO_L04P_2/VS2	IO_L03N_2/VS2	T3	DUAL
2	IO_L03P_2/ RDWR_B	IO_L03P_2/ RDWR_B	R3	DUAL
2	IO_L04N_2/VS0	IO_L04N_2/VS0	P5	DUAL
2	IO_L03N_2/VS1	IO_L04P_2/VS1	N6	DUAL
2	IO_L06P_2	IO_L05N_2	R5	I/O
2	IO_L05P_2	IO_L05P_2	T4	I/O
2	IO_L06N_2/D6	IO_L06N_2/D6	T6	DUAL
2	IO_L05N_2/D7	IO_L06P_2/D7	T5	DUAL
2	N.C. (◆)	IO_L07N_2	P6	I/O
2	N.C. (◆)	IO_L07P_2	N7	I/O
2	IO_L08N_2/D4	IO_L08N_2/D4	N8	DUAL
2	IO_L08P_2/D5	IO_L08P_2/D5	P7	DUAL
2	N.C. (◆)	IO_L09N_2/ GCLK13	T7	GCLK
2	N.C. (◆)	IO_L09P_2/ GCLK12	R7	GCLK
2	IO_L10N_2/ GCLK15	IO_L10N_2/ GCLK15	T8	GCLK
2	IO_L10P_2/ GCLK14	IO_L10P_2/ GCLK14	P8	GCLK
2	IO_L11N_2/ GCLK1	IO_L11N_2/ GCLK1	P9	GCLK
2	IO_L11P_2/ GCLK0	IO_L11P_2/ GCLK0	N9	GCLK
2	IO_L12N_2/ GCLK3	IO_L12N_2/ GCLK3	T9	GCLK
2	IO_L12P_2/ GCLK2	IO_L12P_2/ GCLK2	R9	GCLK
2	N.C. (◆)	IO_L13N_2	M10	I/O
2	N.C. (◆)	IO_L13P_2	N10	I/O
2	IO_L14P_2/ MOSI/CSI_B	IO_L14N_2/ MOSI/CSI_B	P10	DUAL
2	IO_L14N_2	IO_L14P_2	T10	I/O
2	IO_L15N_2/ DOUT	IO_L15N_2/ DOUT	R11	DUAL
2	IO_L15P_2/ AWAKE	IO_L15P_2/ AWAKE	T11	PWR MGMT
2	IO_L16N_2	IO_L16N_2	N11	I/O
2	IO_L16P_2	IO_L16P_2	P11	I/O
2	IO_L17N_2/D3	IO_L17N_2/D3	P12	DUAL
2	IO_L17P_2/ INIT_B	IO_L17P_2/ INIT_B	T12	DUAL

Table 68: Spartan-3A FT256 Pinout (XC3S50A, XC3S200A, XC3S400) (Continued)

Bank	XC3S50A	XC3S200A XC3S400A	FT256 Ball	Type
2	IO_L20P_2/D1	IO_L18N_2/D1	R13	DUAL
2	IO_L18P_2/D2	IO_L18P_2/D2	T13	DUAL
2	N.C. (◆)	IO_L19N_2	P13	I/O
2	N.C. (◆)	IO_L19P_2	N12	I/O
2	IO_L20N_2/ CCLK	IO_L20N_2/ CCLK	R14	DUAL
2	IO_L18N_2/D0/ DIN/MISO	IO_L20P_2/D0/ DIN/MISO	T14	DUAL
2	IP_2	IP_2	L7	INPUT
2	IP_2	IP_2	L8	INPUT
2	IP_2/VREF_2	IP_2/VREF_2	L9	VREF
2	IP_2/VREF_2	IP_2/VREF_2	L10	VREF
2	IP_2/VREF_2	IP_2/VREF_2	M7	VREF
2	IP_2/VREF_2	IP_2/VREF_2	M8	VREF
2	IP_2/VREF_2	IP_2/VREF_2	M11	VREF
2	IP_2/VREF_2	IP_2/VREF_2	N5	VREF
2	VCCO_2	VCCO_2	M9	VCCO
2	VCCO_2	VCCO_2	R4	VCCO
2	VCCO_2	VCCO_2	R8	VCCO
2	VCCO_2	VCCO_2	R12	VCCO
3	IO_L01N_3	IO_L01N_3	C1	I/O
3	IO_L01P_3	IO_L01P_3	C2	I/O
3	IO_L02N_3	IO_L02N_3	D3	I/O
3	IO_L02P_3	IO_L02P_3	D4	I/O
3	IO_L03N_3	IO_L03N_3	E1	I/O
3	IO_L03P_3	IO_L03P_3	D1	I/O
3	N.C. (◆)	IO_L05N_3	E2	I/O
3	N.C. (◆)	IO_L05P_3	E3	I/O
3	N.C. (◆)	IO_L07N_3	G4	I/O
3	N.C. (◆)	IO_L07P_3	F3	I/O
3	IO_L08N_3/ VREF_3	IO_L08N_3/ VREF_3	G1	VREF
3	IO_L08P_3	IO_L08P_3	F1	I/O
3	N.C. (◆)	IO_L09N_3	H4	I/O
3	N.C. (◆)	IO_L09P_3	G3	I/O
3	N.C. (◆)	IO_L10N_3	H5	I/O
3	N.C. (◆)	IO_L10P_3	H6	I/O
3	IO_L11N_3/ LHCLK1	IO_L11N_3/ LHCLK1	H1	LHCLK
3	IO_L11P_3/ LHCLK0	IO_L11P_3/ LHCLK0	G2	LHCLK
3	IO_L12N_3/ IRDY2/LHCLK3	IO_L12N_3/ IRDY2/LHCLK3	J3	LHCLK
3	IO_L12P_3/ LHCLK2	IO_L12P_3/ LHCLK2	H3	LHCLK

XC3S50A Differential I/O Alignment Differences

Also, some differential I/O pairs on the XC3S50A FPGA are aligned differently than the corresponding pairs on the XC3S200A or XC3S400A FPGAs, as shown in Table 74. All the mismatched pairs are in I/O Bank 2. The shading highlights the N side of each pair.

Table 74: Differential I/O Differences in FT256

FT256 Ball	Bank	XC3S50A	XC3S200A XC3S400A
T3	2	IO_L04P_2/VS2	IO_L03N_2/VS2
N6		IO_L03N_2/VS1	IO_L04P_2/VS1
R5		IO_L06P_2	IO_L05N_2
T5		IO_L05N_2/D7	IO_L06P_2/D7
P10		IO_L14P_2/MOSI /CSI_B	IO_L14N_2/MOSI /CSI_B
T10		IO_L14N_2	IO_L14P_2
R13		IO_L20P_2	IO_L18N_2
T14		IO_L18N_2	IO_L20P_2

XC3S50A Does Not Have BPI Mode Address Outputs

The XC3S50A FPGA does not generate the BPI-mode address pins during configuration. Table 75 summarizes these differences.

Table 75: XC3S50A BPI Functional Differences

FT256 Ball	Bank	XC3S50A	XC3S200A XC3S400A
N16	1	IO_L03N_1	IO_L03N_1/A1
P16		IO_L03P_1	IO_L03P_1/A0
J13		IO_L10N_1	IO_L10N_1/A9
J12		IO_L10P_1	IO_L10P_1/A8
F13		IO_L20N_1	IO_L20N_1/A19
E14		IO_L20P_1	IO_L20P_1/A18
D15		IO_L22N_1	IO_L22N_1/A21
D16		IO_L22P_1	IO_L22P_1/A20
D14		IO_L23N_1	IO_L23N_1/A23
E13		IO_L23P_1	IO_L23P_1/A22
C15		IO_L24N_1	IO_L24N_1/A25
C16		IO_L24P_1	IO_L24P_1/A24

Table 77: Spartan-3A FG320 Pinout(Continued)

Bank	Pin Name	FG320 Ball	Type
3	IO_L10N_3/VREF_3	F1	VREF
3	IO_L10P_3	F2	I/O
3	IO_L11N_3	J6	I/O
3	IO_L11P_3	J7	I/O
3	IO_L13N_3	H1	I/O
3	IO_L13P_3	H2	I/O
3	IO_L14N_3/LHCLK1	J3	LHCLK
3	IO_L14P_3/LHCLK0	H3	LHCLK
3	IO_L15N_3/IRDY2/LHCLK3	J1	LHCLK
3	IO_L15P_3/LHCLK2	J2	LHCLK
3	IO_L17N_3/LHCLK5	K5	LHCLK
3	IO_L17P_3/LHCLK4	J4	LHCLK
3	IO_L18N_3/LHCLK7	K3	LHCLK
3	IO_L18P_3/TRDY2/LHCLK6	K2	LHCLK
3	IO_L19N_3	L2	I/O
3	IO_L19P_3/VREF_3	L1	VREF
3	IO_L21N_3	M2	I/O
3	IO_L21P_3	N1	I/O
3	IO_L22N_3	N2	I/O
3	IO_L22P_3	P1	I/O
3	IO_L23N_3	L4	I/O
3	IO_L23P_3	L3	I/O
3	IO_L25N_3	R2	I/O
3	IO_L25P_3	R1	I/O
3	IO_L26N_3	N4	I/O
3	IO_L26P_3	N3	I/O
3	IO_L27N_3	T2	I/O
3	IO_L27P_3	T1	I/O
3	IO_L29N_3	N6	I/O
3	IO_L29P_3	N5	I/O
3	IO_L30N_3	R3	I/O
3	IO_L30P_3	P3	I/O
3	IO_L31N_3	U2	I/O
3	IO_L31P_3	U1	I/O
3	IP_L04N_3/VREF_3	H7	VREF
3	IP_L04P_3	G6	INPUT
3	IP_L08N_3/VREF_3	H5	VREF
3	IP_L08P_3	H6	INPUT
3	IP_L12N_3	G2	INPUT
3	IP_L12P_3	G3	INPUT

Table 77: Spartan-3A FG320 Pinout(Continued)

Bank	Pin Name	FG320 Ball	Type
3	IP_L16N_3	K6	INPUT
3	IP_L16P_3	J5	INPUT
3	IP_L20N_3	L6	INPUT
3	IP_L20P_3	L7	INPUT
3	IP_L24N_3	M4	INPUT
3	IP_L24P_3	M3	INPUT
3	IP_L28N_3	M5	INPUT
3	IP_L28P_3	M6	INPUT
3	IP_L32N_3/VREF_3	P4	VREF
3	IP_L32P_3	P5	INPUT
3	VCCO_3	E2	VCCO
3	VCCO_3	H4	VCCO
3	VCCO_3	L5	VCCO
3	VCCO_3	P2	VCCO
GND	GND	A1	GND
GND	GND	A7	GND
GND	GND	A12	GND
GND	GND	A18	GND
GND	GND	C10	GND
GND	GND	D4	GND
GND	GND	D7	GND
GND	GND	D15	GND
GND	GND	F6	GND
GND	GND	G1	GND
GND	GND	G12	GND
GND	GND	G18	GND
GND	GND	H8	GND
GND	GND	H10	GND
GND	GND	J11	GND
GND	GND	J15	GND
GND	GND	K4	GND
GND	GND	K8	GND
GND	GND	L9	GND
GND	GND	L11	GND
GND	GND	M1	GND
GND	GND	M7	GND
GND	GND	M18	GND
GND	GND	N13	GND
GND	GND	R4	GND
GND	GND	R12	GND

Table 81: Spartan-3A FG400 Pinout(Continued)

Bank	Pin Name	FG400 Ball	Type
2	IO_L28P_2	Y16	I/O
2	IO_L29N_2	U16	I/O
2	IO_L29P_2	V16	I/O
2	IO_L30N_2	Y18	I/O
2	IO_L30P_2	Y17	I/O
2	IO_L31N_2	U17	I/O
2	IO_L31P_2	V17	I/O
2	IO_L32N_2/CCLK	Y19	DUAL
2	IO_L32P_2/D0/DIN/MISO	W18	DUAL
2	IP_2	P9	INPUT
2	IP_2	P12	INPUT
2	IP_2	P13	INPUT
2	IP_2	R8	INPUT
2	IP_2	R10	INPUT
2	IP_2	T11	INPUT
2	IP_2/VREF_2	N9	VREF
2	IP_2/VREF_2	N12	VREF
2	IP_2/VREF_2	P8	VREF
2	IP_2/VREF_2	P10	VREF
2	IP_2/VREF_2	P11	VREF
2	IP_2/VREF_2	R14	VREF
2	VCCO_2	R11	VCCO
2	VCCO_2	U8	VCCO
2	VCCO_2	U14	VCCO
2	VCCO_2	W5	VCCO
2	VCCO_2	W11	VCCO
2	VCCO_2	W17	VCCO
3	IO_L01N_3	D3	I/O
3	IO_L01P_3	D4	I/O
3	IO_L02N_3	C2	I/O
3	IO_L02P_3	B1	I/O
3	IO_L03N_3	D2	I/O
3	IO_L03P_3	C1	I/O
3	IO_L05N_3	E1	I/O
3	IO_L05P_3	D1	I/O
3	IO_L06N_3	G5	I/O
3	IO_L06P_3	F4	I/O
3	IO_L07N_3	J5	I/O
3	IO_L07P_3	J6	I/O
3	IO_L08N_3	H4	I/O

Table 81: Spartan-3A FG400 Pinout(Continued)

Bank	Pin Name	FG400 Ball	Type
3	IO_L08P_3	H6	I/O
3	IO_L09N_3	G4	I/O
3	IO_L09P_3	F3	I/O
3	IO_L10N_3	F2	I/O
3	IO_L10P_3	E3	I/O
3	IO_L12N_3	H2	I/O
3	IO_L12P_3	G3	I/O
3	IO_L13N_3/VREF_3	G1	VREF
3	IO_L13P_3	F1	I/O
3	IO_L14N_3	H3	I/O
3	IO_L14P_3	J4	I/O
3	IO_L16N_3	J2	I/O
3	IO_L16P_3	J3	I/O
3	IO_L17N_3/LHCLK1	K2	LHCLK
3	IO_L17P_3/LHCLK0	J1	LHCLK
3	IO_L18N_3/IRDY2/LHCLK3	L3	LHCLK
3	IO_L18P_3/LHCLK2	K3	LHCLK
3	IO_L20N_3/LHCLK5	L5	LHCLK
3	IO_L20P_3/LHCLK4	K4	LHCLK
3	IO_L21N_3/LHCLK7	M1	LHCLK
3	IO_L21P_3/TRDY2/LHCLK6	L1	LHCLK
3	IO_L22N_3	M3	I/O
3	IO_L22P_3/VREF_3	M2	VREF
3	IO_L24N_3	M5	I/O
3	IO_L24P_3	M4	I/O
3	IO_L25N_3	N2	I/O
3	IO_L25P_3	N1	I/O
3	IO_L26N_3	N4	I/O
3	IO_L26P_3	N3	I/O
3	IO_L28N_3	R1	I/O
3	IO_L28P_3	P1	I/O
3	IO_L29N_3	P4	I/O
3	IO_L29P_3	P3	I/O
3	IO_L30N_3	R3	I/O
3	IO_L30P_3	R2	I/O
3	IO_L32N_3	T2	I/O
3	IO_L32P_3/VREF_3	T1	VREF
3	IO_L33N_3	R4	I/O
3	IO_L33P_3	T3	I/O
3	IO_L34N_3	U3	I/O

Table 81: Spartan-3A FG400 Pinout(Continued)

Bank	Pin Name	FG400 Ball	Type
3	IO_L34P_3	U1	I/O
3	IO_L36N_3	T4	I/O
3	IO_L36P_3	R5	I/O
3	IO_L37N_3	V2	I/O
3	IO_L37P_3	V1	I/O
3	IO_L38N_3	W2	I/O
3	IO_L38P_3	W1	I/O
3	IP_3	H7	INPUT
3	IP_L04N_3/VREF_3	G6	VREF
3	IP_L04P_3	G7	INPUT
3	IP_L11N_3/VREF_3	J7	VREF
3	IP_L11P_3	J8	INPUT
3	IP_L15N_3	K7	INPUT
3	IP_L15P_3	K8	INPUT
3	IP_L19N_3	K5	INPUT
3	IP_L19P_3	K6	INPUT
3	IP_L23N_3	L6	INPUT
3	IP_L23P_3	L7	INPUT
3	IP_L27N_3	M7	INPUT
3	IP_L27P_3	M8	INPUT
3	IP_L31N_3	N7	INPUT
3	IP_L31P_3	M6	INPUT
3	IP_L35N_3	N6	INPUT
3	IP_L35P_3	P5	INPUT
3	IP_L39N_3/VREF_3	P7	VREF
3	IP_L39P_3	P6	INPUT
3	VCCO_3	E2	VCCO
3	VCCO_3	H5	VCCO
3	VCCO_3	L2	VCCO
3	VCCO_3	N5	VCCO
3	VCCO_3	U2	VCCO
GND	GND	A1	GND
GND	GND	A11	GND
GND	GND	A20	GND
GND	GND	B6	GND
GND	GND	B14	GND
GND	GND	C3	GND
GND	GND	C18	GND
GND	GND	D9	GND
GND	GND	E5	GND

Table 81: Spartan-3A FG400 Pinout(Continued)

Bank	Pin Name	FG400 Ball	Type
GND	GND	E12	GND
GND	GND	F15	GND
GND	GND	G2	GND
GND	GND	G19	GND
GND	GND	H8	GND
GND	GND	H13	GND
GND	GND	J9	GND
GND	GND	J11	GND
GND	GND	K1	GND
GND	GND	K10	GND
GND	GND	K12	GND
GND	GND	K17	GND
GND	GND	L4	GND
GND	GND	L9	GND
GND	GND	L11	GND
GND	GND	L20	GND
GND	GND	M10	GND
GND	GND	M12	GND
GND	GND	N8	GND
GND	GND	N11	GND
GND	GND	N13	GND
GND	GND	P2	GND
GND	GND	P19	GND
GND	GND	R6	GND
GND	GND	R9	GND
GND	GND	T16	GND
GND	GND	U12	GND
GND	GND	V3	GND
GND	GND	V18	GND
GND	GND	W7	GND
GND	GND	W15	GND
GND	GND	Y1	GND
GND	GND	Y10	GND
GND	GND	Y20	GND
VCCAUX	SUSPEND	R15	PWR MGMT
VCCAUX	DONE	W19	CONFIG
VCCAUX	PROG_B	D5	CONFIG
VCCAUX	TCK	A19	JTAG
VCCAUX	TDI	F5	JTAG

Table 87: Spartan-3A FG676 Pinout(Continued)

Bank	Pin Name	FG676 Ball	Type
2	IP_2	AD10	INPUT
2	IP_2	AD16	INPUT
2	IP_2	AF2	INPUT
2	IP_2	AF7	INPUT
2	IP_2	Y11	INPUT
2	IP_2/VREF_2	AA9	VREF
2	IP_2/VREF_2	AA20	VREF
2	IP_2/VREF_2	AB6	VREF
2	IP_2/VREF_2	AB10	VREF
2	IP_2/VREF_2	AC10	VREF
2	IP_2/VREF_2	AD12	VREF
2	IP_2/VREF_2	AF15	VREF
2	IP_2/VREF_2	AF17	VREF
2	IP_2/VREF_2	AF22	VREF
2	IP_2/VREF_2	Y16	VREF
2	N.C. (◆)	AA8	N.C.
2	N.C. (◆)	AC5	N.C.
2	N.C. (◆)	AC22	N.C.
2	N.C. (◆)	AD5	N.C.
2	N.C. (◆)	Y18	N.C.
2	N.C. (◆)	Y19	N.C.
2	N.C. (◆)	AD23	N.C.
2	N.C. (◆)	W18	N.C.
2	N.C. (◆)	Y8	N.C.
2	VCCO_2	AB8	VCCO
2	VCCO_2	AB14	VCCO
2	VCCO_2	AB19	VCCO
2	VCCO_2	AE5	VCCO
2	VCCO_2	AE11	VCCO
2	VCCO_2	AE16	VCCO
2	VCCO_2	AE22	VCCO
2	VCCO_2	W11	VCCO
2	VCCO_2	W16	VCCO
3	IO_L01N_3	J9	I/O
3	IO_L01P_3	J8	I/O
3	IO_L02N_3	B1	I/O
3	IO_L02P_3	B2	I/O
3	IO_L03N_3	H7	I/O
3	IO_L03P_3	G6	I/O
3	IO_L05N_3	K8	I/O

Table 87: Spartan-3A FG676 Pinout(Continued)

Bank	Pin Name	FG676 Ball	Type
3	IO_L05P_3	K9	I/O
3	IO_L06N_3	E4	I/O
3	IO_L06P_3	D3	I/O
3	IO_L07N_3	F4	I/O
3	IO_L07P_3	E3	I/O
3	IO_L09N_3	G4	I/O
3	IO_L09P_3	F5	I/O
3	IO_L10N_3	H6	I/O
3	IO_L10P_3	J7	I/O
3	IO_L11N_3	F2	I/O
3	IO_L11P_3	E1	I/O
3	IO_L13N_3	J6	I/O
3	IO_L13P_3	K7	I/O
3	IO_L14N_3	F3	I/O
3	IO_L14P_3	G3	I/O
3	IO_L15N_3	L9	I/O
3	IO_L15P_3	L10	I/O
3	IO_L17N_3	H1	I/O
3	IO_L17P_3	H2	I/O
3	IO_L18N_3	L7	I/O
3	IO_L18P_3	K6	I/O
3	IO_L19N_3	J4	I/O
3	IO_L19P_3	J5	I/O
3	IO_L21N_3	M9	I/O
3	IO_L21P_3	M10	I/O
3	IO_L22N_3	K4	I/O
3	IO_L22P_3	K5	I/O
3	IO_L23N_3	K2	I/O
3	IO_L23P_3	K3	I/O
3	IO_L25N_3	L3	I/O
3	IO_L25P_3	L4	I/O
3	IO_L26N_3	M7	I/O
3	IO_L26P_3	M8	I/O
3	IO_L27N_3	M3	I/O
3	IO_L27P_3	M4	I/O
3	IO_L28N_3	M6	I/O
3	IO_L28P_3	M5	I/O
3	IO_L29N_3/VREF_3	M1	VREF
3	IO_L29P_3	M2	I/O
3	IO_L30N_3	N4	I/O